

SEP 16 2004

REPLY UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 1765PATENT
5298-06900/PM01027IN THE UNITED STATES PATENT AND TRADEMARK OFFICEIn re Application of:
Schwarz

Serial No. 10/074,888

Filed: February 13, 2002

For: REDUCING DEFECT FORMATION
WITHIN AN ETCHED
SEMICONDUCTOR TOPOGRAPHYGroup Art Unit: 1765
Examiner: Deo, D.

Atty. Dkt. No. 5298-06900

I hereby certify that this correspondence is being transmitted via
facsimile or deposited with the U.S. Postal Service with sufficient
postage as First Class Mail in an envelope addressed to:
Commissioner for Patents, P.O. Box 1450, Alexandria, VA
22313, on the date indicated below:

September 16, 2004
Date

Kovir L. Daffier

AMENDMENT: RESPONSE TO FINAL OFFICE ACTION DATED JULY 23, 2004Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

Dear Sir/ Madam:

This paper is submitted in response to the final Office Action dated July 23, 2004 to further
highlight reasons why the application is in condition for allowance.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 7 of this paper.